

7MBR75XWE120-50

IGBT Modules

Power Module(X series)
1200V / 75A / PIM

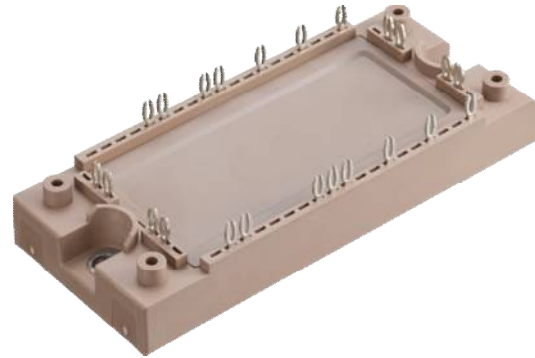
■ Features

- Low $V_{CE(sat)}$
- Compact Package
- P.C.Board Mount Module
- Converter Diode Bridge Dynamic Brake Circuit
- RoHS compliant Product

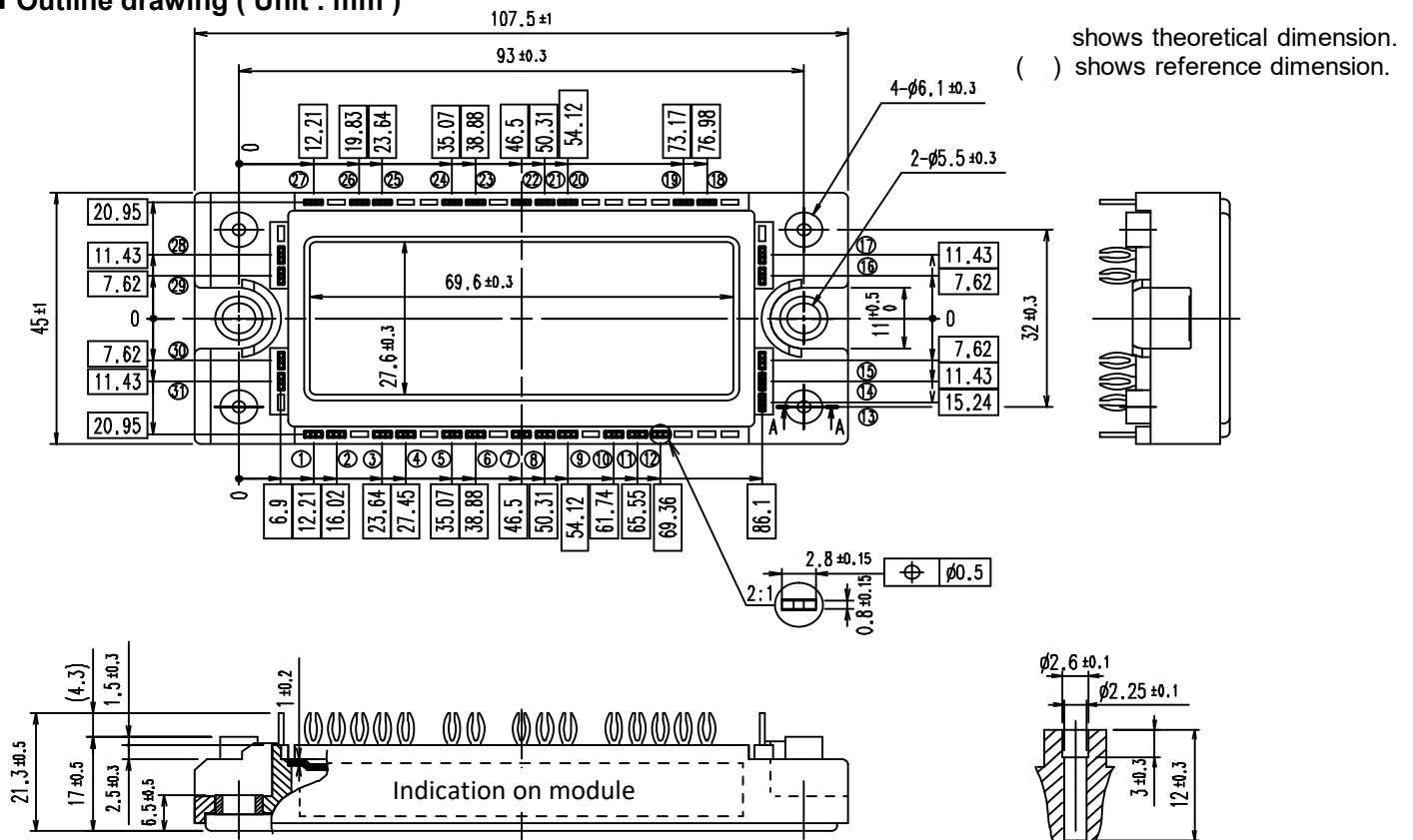
■ Applications

- Inverter for Motor Drive
- AC and DC Servo Drive Amplifier
- Uninterrupted Power Supply

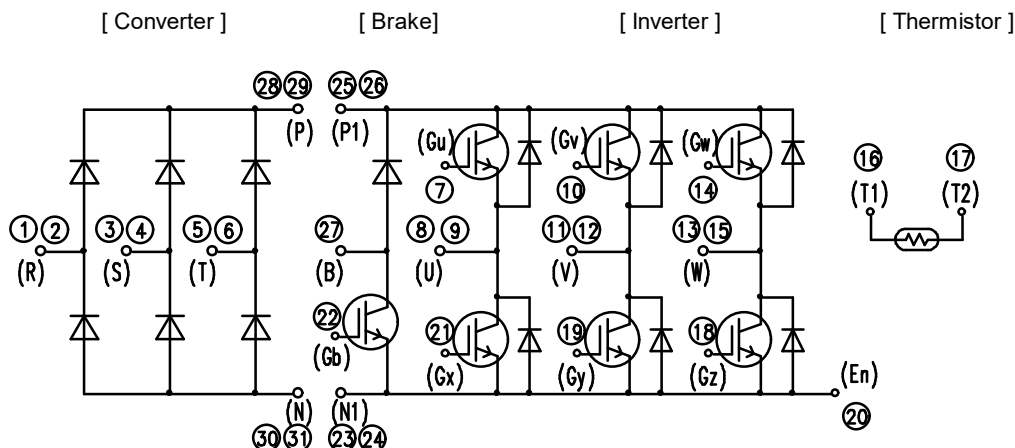
■ Typical appearance



■ Outline drawing (Unit : mm)



■ Equivalent circuit



Weight: 200 g (typ.)

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IGBT Modules
■ Maximum ratings (at $T_c = 25^\circ\text{C}$ unless otherwise specified)

	Items	Symbols	Conditions		Maximum ratings	Units
Inverter	Collector-Emitter voltage, Gate-Emitter short-circuited	V_{CES}			1200	V
	Gate-Emitter voltage, Collector-Emitter short-circuited	V_{GES}			± 20	V
	Collector current	I_C	Continuous	$T_c = 100^\circ\text{C}$	75	A
	Repetitived peak collector current	I_{CRM}	1ms		150	
	Forward current	I_F	Continuous		75	
	Repetitived peak forward current	I_{FRM}	1ms		150	
	Total power dissipation	P_{tot}	1 device		455	W
Brake IGBT	Collector-Emitter voltage, Gate-Emitter short-circuited	V_{CES}			1200	V
	Gate-Emitter voltage, Collector-Emitter short-circuited	V_{GES}			± 20	V
	Collector current	I_C	Continuous	$T_c = 100^\circ\text{C}$	35	A
	Repetitived peak collector current	I_{CRM}	1ms		70	
	Total power dissipation	P_{tot}	1 device		200	W
Brake FWD	Forward current	I_F	Continuous		15	A
	Repetitived peak forward current	I_{FRM}	1ms		30	
	Repetitive peak reverse voltage	V_{RRM}			1200	V
Converter	Repetitive peak reverse voltage	V_{RRM}			1600	V
	Average output current	I_O	Three-phase full wave rectified current	$T_c = 80^\circ\text{C}$	75	A
	Surge current (Non-Repetitive) (*1)	I_{FSM}	$t = 10\text{ms}$, Half sine wave form	$T_{vj} = 25^\circ\text{C}$	630	A
				$T_{vj} = 150^\circ\text{C}$	520	
	I^2t (Non-Repetitive) (*1)	I^2t		$T_{vj} = 25^\circ\text{C}$	2000	A^2s
				$T_{vj} = 150^\circ\text{C}$	1350	
Virtual junction temperature		T_{vj}	Inverter, Brake		175	$^\circ\text{C}$
			Converter		150	
Operating virtual junction temperature (under switching conditions)		T_{vjop}	Inverter, Brake		175	
			Converter		150	
Case temperature		T_c			125	
Storage temperature		T_{stg}			-40 ~ 125	
Isolation voltage	between terminals and copper base (*2)	V_{isol}	A.C. : 1min.		2500	Vrms
	between thermistor and others (*3)					
Screw torque	Mounting torque of screws to heat sink	M_s	M5		2.5 ~ 6.0	N·m

(*1) T_{vj} : Temperature at the start of the test.

(*2) All terminals should be connected together during the test.

(*3) Two thermistor terminals should be connected together, other terminals should be connected together and shorted to base plate during the test.

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■ Electrical characteristics (at $T_{vj} = 25^{\circ}\text{C}$ unless otherwise specified)

Items		Symbols	Conditions		Characteristics			Units
					min.	typ.	max.	
Inverter	Collector-Emitter cut-off current, Gate-Emitter short-circuited	I_{CES}	$V_{\text{GE}} = 0\text{V}$ $V_{\text{CE}} = 1200\text{V}$		-	-	50	μA
	Gate leakage current,Collector-Emitter short-circuited	I_{GES}	$V_{\text{CE}} = 0\text{V}$ $V_{\text{GE}} = +20/-20\text{V}$		-	-	100	nA
	Gate-Emitter threshold voltage	$V_{\text{GE(th)}}$	$V_{\text{CE}} = 20\text{V}$ $I_{\text{C}} = 75\text{mA}$		6.0	6.5	7.0	V
	Collector-Emitter saturation voltage	$V_{\text{CE(sat)}}$ (terminal)	$V_{\text{GE}} = 15\text{V}$ $I_{\text{C}} = 75\text{A}$	$T_{\text{vj}}\!=\!25^{\circ}\text{C}$	-	1.75	2.25	V
				$T_{\text{vj}}\!=\!25^{\circ}\text{C}$	-	1.55	2.00	
		$V_{\text{CE(sat)}}$ (chip)		$T_{\text{vj}}\!=\!125^{\circ}\text{C}$	-	1.95	-	
				$T_{\text{vj}}\!=\!150^{\circ}\text{C}$	-	2.05	-	
				$T_{\text{vj}}\!=\!175^{\circ}\text{C}$	-	2.10	-	
	Internal gate resistance	r_{g}	-		-	0	-	Ω
	Capacitance	C_{ies}	$V_{\text{CE}} = 10\text{V}, V_{\text{GE}} = 0\text{V}, f = 1\text{MHz}$		-	7.4	-	nF
		C_{oes}			-	0.25	-	
		C_{res}			-	0.07	-	
	Gate charge	Q_{G}	$V_{\text{CC}} = 600\text{V} \quad V_{\text{GE}}\!=\!-15 \rightarrow +15\text{V}$ $I_{\text{C}} = 75\text{A}$		-	470	-	nC
	Forward voltage	V_{F} (terminal)	$I_{\text{F}} = 75\text{A}$	$T_{\text{vj}}\!=\!25^{\circ}\text{C}$	-	2.25	2.75	V
		V_{F} (chip)		$T_{\text{vj}}\!=\!25^{\circ}\text{C}$	-	2.05	2.50	
				$T_{\text{vj}}\!=\!125^{\circ}\text{C}$	-	2.15	-	
				$T_{\text{vj}}\!=\!150^{\circ}\text{C}$	-	2.15	-	
				$T_{\text{vj}}\!=\!175^{\circ}\text{C}$	-	2.10	-	
Switching time (*1)	$t_{\text{d(on)}}$	$V_{\text{CC}} = 600\text{V}$ $I_{\text{C}}, I_{\text{F}} = 75\text{A} \quad L_{\text{s}} = 30\text{nH}$ $V_{\text{GE}} = +15/-15\text{ V}$ $R_{\text{G}} = 12\ \Omega$	$T_{\text{vj}}\!=\!25^{\circ}\text{C}$	-	0.11	-	μs	
			$T_{\text{vj}}\!=\!125^{\circ}\text{C}$	-	0.11	-		
			$T_{\text{vj}}\!=\!150^{\circ}\text{C}$	-	0.11	-		
			$T_{\text{vj}}\!=\!175^{\circ}\text{C}$	-	0.12	-		
	t_{r}	$V_{\text{CC}} = 600\text{V}$ $I_{\text{C}}, I_{\text{F}} = 75\text{A} \quad L_{\text{s}} = 30\text{nH}$ $V_{\text{GE}} = +15/-15\text{ V}$ $R_{\text{G}} = 12\ \Omega$	$T_{\text{vj}}\!=\!25^{\circ}\text{C}$	-	0.04	-		
			$T_{\text{vj}}\!=\!125^{\circ}\text{C}$	-	0.04	-		
			$T_{\text{vj}}\!=\!150^{\circ}\text{C}$	-	0.04	-		
			$T_{\text{vj}}\!=\!175^{\circ}\text{C}$	-	0.04	-		
	$t_{\text{d(off)}}$	$V_{\text{CC}} = 600\text{V}$ $I_{\text{C}}, I_{\text{F}} = 75\text{A} \quad L_{\text{s}} = 30\text{nH}$ $V_{\text{GE}} = +15/-15\text{ V}$ $R_{\text{G}} = 12\ \Omega$	$T_{\text{vj}}\!=\!25^{\circ}\text{C}$	-	0.23	-		
			$T_{\text{vj}}\!=\!125^{\circ}\text{C}$	-	0.26	-		
			$T_{\text{vj}}\!=\!150^{\circ}\text{C}$	-	0.26	-		
			$T_{\text{vj}}\!=\!175^{\circ}\text{C}$	-	0.27	-		
	t_{f}	$V_{\text{CC}} = 600\text{V}$ $I_{\text{C}}, I_{\text{F}} = 75\text{A} \quad L_{\text{s}} = 30\text{nH}$ $V_{\text{GE}} = +15/-15\text{ V}$ $R_{\text{G}} = 12\ \Omega$	$T_{\text{vj}}\!=\!25^{\circ}\text{C}$	-	0.13	-		
			$T_{\text{vj}}\!=\!125^{\circ}\text{C}$	-	0.21	-		
			$T_{\text{vj}}\!=\!150^{\circ}\text{C}$	-	0.22	-		
			$T_{\text{vj}}\!=\!175^{\circ}\text{C}$	-	0.24	-		
Reverse recovery time	t_{rr}	$V_{\text{CC}} = 600\text{V}$ $I_{\text{C}}, I_{\text{F}} = 75\text{A} \quad L_{\text{s}} = 30\text{nH}$ $V_{\text{GE}} = +15/-15\text{ V}$ $R_{\text{G}} = 12\ \Omega$	$T_{\text{vj}}\!=\!25^{\circ}\text{C}$	-	0.09	-		
			$T_{\text{vj}}\!=\!125^{\circ}\text{C}$	-	0.12	-		
			$T_{\text{vj}}\!=\!150^{\circ}\text{C}$	-	0.14	-		
			$T_{\text{vj}}\!=\!175^{\circ}\text{C}$	-	0.16	-		

(*1) Turn on time (t_{on}) = $t_{d(on)} + t_r$, Turn off time (t_{off}) = $t_{d(off)} + t_f$

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Items		Symbols	Conditions		Characteristics			Units
					min.	typ.	max.	
Inverter	Switching loss (per pulse)	E_{on}	$V_{CC} = 600V$	$T_{vj}=25^{\circ}C$	-	4.65	-	mJ
			$I_C, I_F = 75A \quad L_s = 30nH$	$T_{vj}=125^{\circ}C$	-	5.92	-	
			$V_{GE} = +15/-15 V$	$T_{vj}=150^{\circ}C$	-	6.51	-	
			$R_G = 12 \Omega$	$T_{vj}=175^{\circ}C$	-	7.08	-	
		E_{off}	$V_{CC} = 600V$	$T_{vj}=25^{\circ}C$	-	5.31	-	
			$I_C, I_F = 75A \quad L_s = 30nH$	$T_{vj}=125^{\circ}C$	-	6.92	-	
			$V_{GE} = +15/-15 V$	$T_{vj}=150^{\circ}C$	-	7.41	-	
			$R_G = 12 \Omega$	$T_{vj}=175^{\circ}C$	-	7.89	-	
		E_{rr}	$V_{CC} = 600V$	$T_{vj}=25^{\circ}C$	-	2.02	-	
			$I_C, I_F = 75A \quad L_s = 30nH$	$T_{vj}=125^{\circ}C$	-	3.62	-	
$V_{GE} = +15/-15 V$	$T_{vj}=150^{\circ}C$		-	4.22	-			
$R_G = 12 \Omega$	$T_{vj}=175^{\circ}C$		-	4.77	-			
Collector-Emitter cut-off current, Gate-Emitter short-circuited		I_{CES}	$V_{GE} = 0V$ $V_{CE} = 1200V$		-	-	50	μA
Gate leakage current, Collector-Emitter short-circuited		I_{GES}	$V_{CE} = 0V, \quad V_{GE} = +20/-20V$ $V_{GE} = +20/-20V$		-	-	100	nA
Collector-Emitter saturation voltage		$V_{CE(sat)}$ (terminal)	$V_{GE} = 15V$ $I_C = 35A$	$T_{vj}=25^{\circ}C$	-	1.60	2.05	V
		$V_{CE(sat)}$ (chip)		$T_{vj}=25^{\circ}C$	-	1.50	1.95	
				$T_{vj}=125^{\circ}C$	-	1.85	-	
				$T_{vj}=150^{\circ}C$	-	1.95	-	
				$T_{vj}=175^{\circ}C$	-	2.00	-	
Internal gate resistance		r_g	-		-	0	-	Ω
Brake	Switching time (*1)	$t_{d(on)}$	$V_{CC} = 600V$	$T_{vj}=25^{\circ}C$	-	0.10	-	μs
			$I_C = 35A \quad L_s = 30nH$	$T_{vj}=125^{\circ}C$	-	0.10	-	
			$V_{GE} = +15/-15 V$	$T_{vj}=150^{\circ}C$	-	0.11	-	
			$R_G = 30 \Omega$	$T_{vj}=175^{\circ}C$	-	0.11	-	
		t_r	$V_{CC} = 600V$	$T_{vj}=25^{\circ}C$	-	0.04	-	
			$I_C = 35A \quad L_s = 30nH$	$T_{vj}=125^{\circ}C$	-	0.05	-	
			$V_{GE} = +15/-15 V$	$T_{vj}=150^{\circ}C$	-	0.05	-	
			$R_G = 30 \Omega$	$T_{vj}=175^{\circ}C$	-	0.05	-	
		$t_{d(off)}$	$V_{CC} = 600V$	$T_{vj}=25^{\circ}C$	-	0.23	-	
			$I_C = 35A \quad L_s = 30nH$	$T_{vj}=125^{\circ}C$	-	0.27	-	
			$V_{GE} = +15/-15 V$	$T_{vj}=150^{\circ}C$	-	0.27	-	
			$R_G = 30 \Omega$	$T_{vj}=175^{\circ}C$	-	0.27	-	
		t_f	$V_{CC} = 600V$	$T_{vj}=25^{\circ}C$	-	0.12	-	
			$I_C = 35A \quad L_s = 30nH$	$T_{vj}=125^{\circ}C$	-	0.18	-	
$V_{GE} = +15/-15 V$	$T_{vj}=150^{\circ}C$		-	0.20	-			
$R_G = 30 \Omega$	$T_{vj}=175^{\circ}C$		-	0.21	-			
Reverse current		I_{RRM}	$V_R = 1200V$		-	-	50	μA
Forward voltage		V_F (terminal)	$I_F = 15A$	$T_{vj}=25^{\circ}C$	-	1.90	2.35	V
		V_F (chip)	$I_F = 15A$	$T_{vj}=25^{\circ}C$	-	1.80	2.25	
				$T_{vj}=125^{\circ}C$	-	1.85	-	
				$T_{vj}=150^{\circ}C$	-	1.80	-	
				$T_{vj}=175^{\circ}C$	-	1.75	-	
Converter	Reverse current	I_{RRM}	$V_R = 1600V$		-	-	50	μA
	Continuous (direct) forward voltage	V_F	$I_F = 75A$	terminal	-	1.35	1.85	V
				chip	-	1.15	1.60	
Thermistor	Resistance	R	$T = 25^{\circ}C$		-	5000	-	Ω
			$T = 100^{\circ}C$		465	495	520	
	B value	B	$T = 25/ 50^{\circ}C$		3305	3375	3450	K

(*1) Turn on time (t_{on}) = $t_{d(on)} + t_r$, Turn off time (t_{off}) = $t_{d(off)} + t_f$

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NOTICE:
The external gate resistance (R_G) shown above is one of our recommended value for the purpose of minimum switching loss. However the optimum R_G depends on circuit configuration and/or environment. We recommend that the R_G has to be carefully chosen based on consideration if IGBT module matches design criteria, for example, switching loss, EMC/EMI, spike voltage, surge current and no unexpected oscillation and so on.

■ Thermal resistance characteristics

Items	Symbols	Conditions	Characteristics			Units
			min.	typ.	max.	
Thermal resistance junction to case (1 device)	$R_{th(j-c)}$	Inverter IGBT	-	-	0.33	K/W
		Inverter FWD	-	-	0.55	
		Brake IGBT	-	-	0.74	
		Brake FWD	-	-	1.85	
		Converter Diode	-	-	0.72	
Thermal resistance case to heat sink(1 IGBT+1 FWD) (*1)	$R_{th(c-s)}$	with 1 W/(m·K) thermal grease	-	0.05	-	

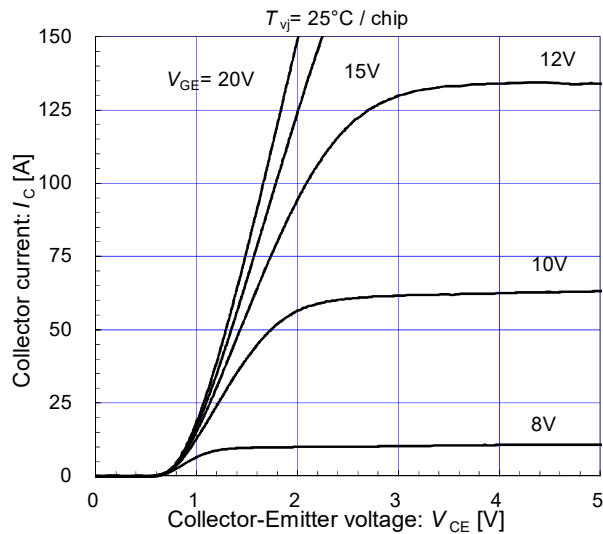
(*1) This is the value which is defined mounting on the additional heat sink with thermal grease.

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IGBT Modules

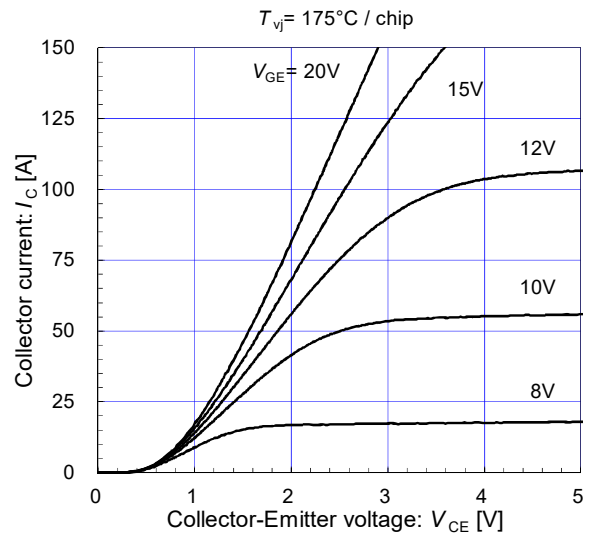
[Inverter]

Collector current vs. Collector-Emitter voltage (typ.)



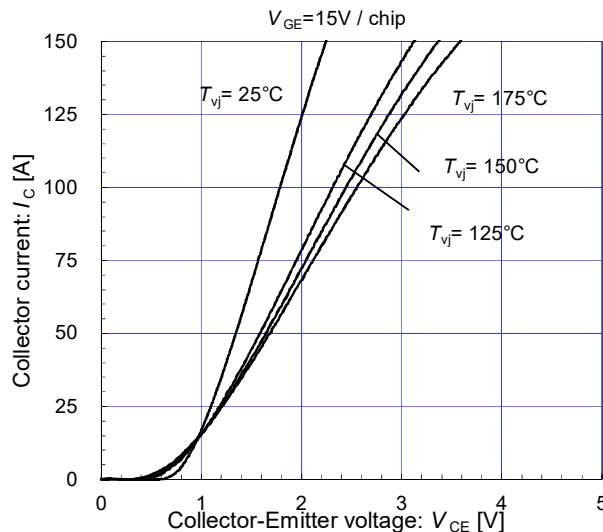
[Inverter]

Collector current vs. Collector-Emitter voltage (typ.)



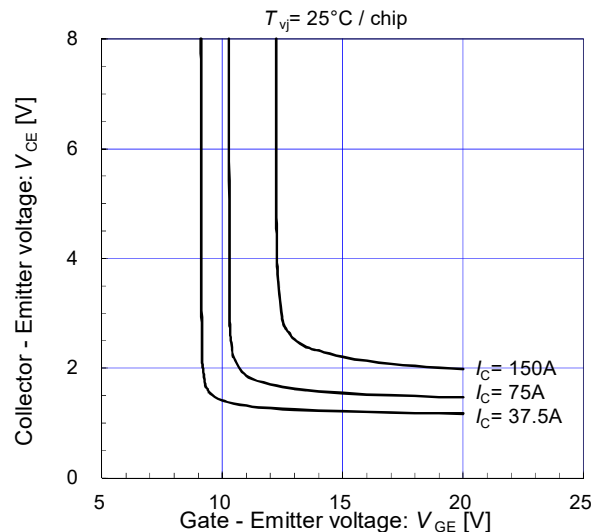
[Inverter]

Collector current vs. Collector-Emitter voltage (typ.)



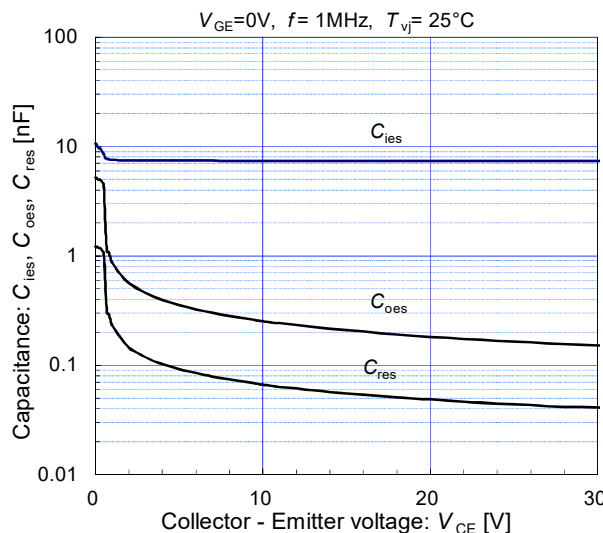
[Inverter]

Collector-Emitter voltage vs. Gate-Emitter voltage (typ.)



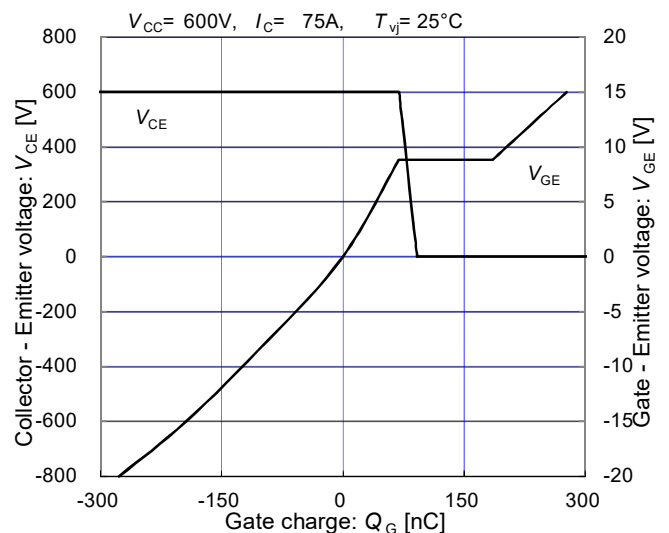
[Inverter]

Capacitance vs. Collector-Emitter voltage (typ.)



[Inverter]

Dynamic gate charge (typ.)



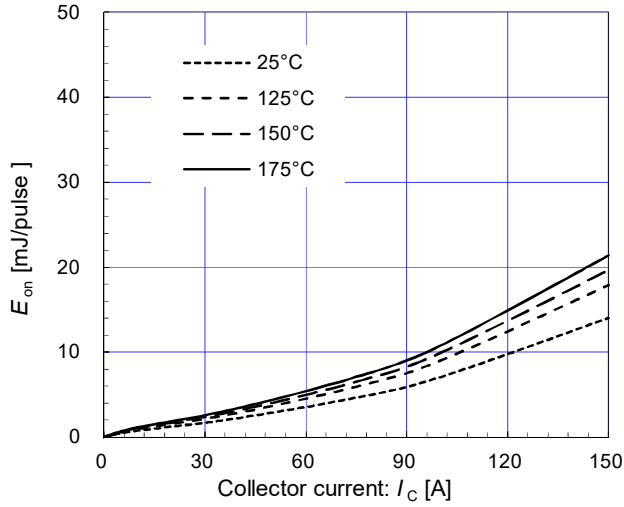
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IGBT Modules

[Inverter]

E_{on} vs. Collector current (typ.)

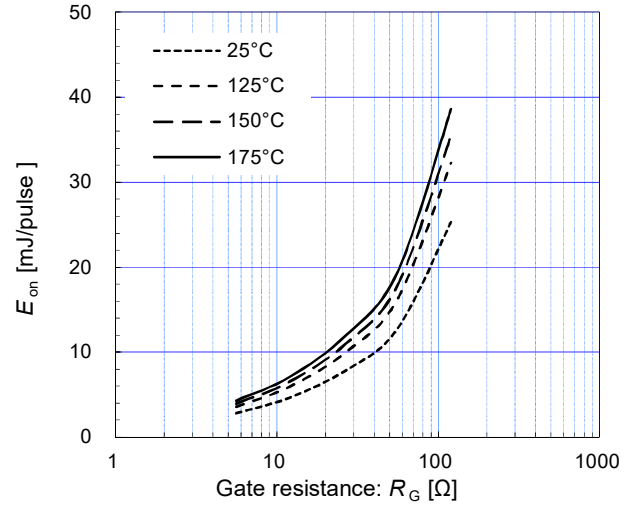
$V_{CC}=600V$, $V_{GE}=+15/-15V$, $R_G=12\Omega$



[Inverter]

E_{on} vs. Gate resistance (typ.)

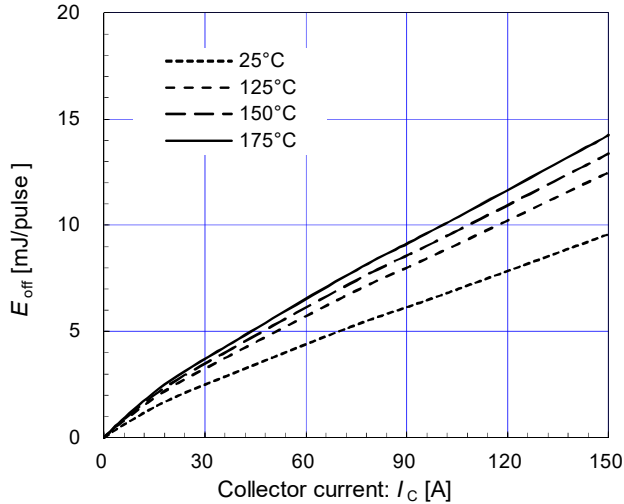
$V_{CC}=600V$, $V_{GE}=+15/-15V$, $I_C=75A$



[Inverter]

E_{off} vs. Collector current (typ.)

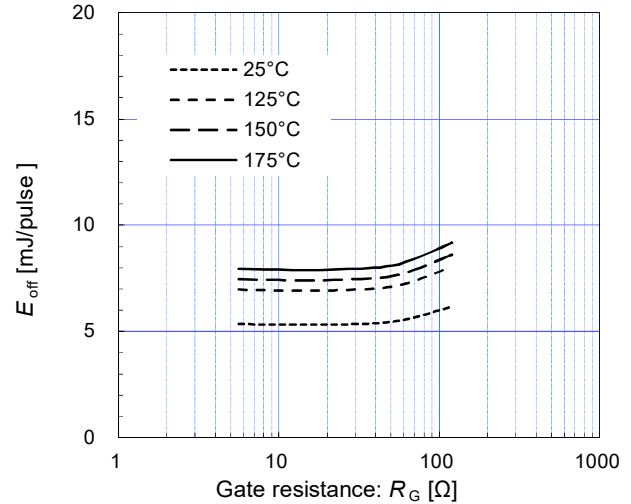
$V_{CC}=600V$, $V_{GE}=+15/-15V$, $R_G=12\Omega$



[Inverter]

E_{off} vs. Gate resistance (typ.)

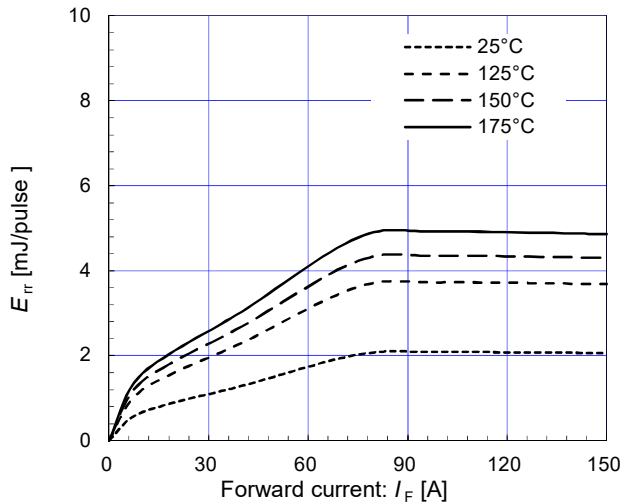
$V_{CC}=600V$, $V_{GE}=+15/-15V$, $I_C=75A$



[Inverter]

E_{rr} vs. Forward current (typ.)

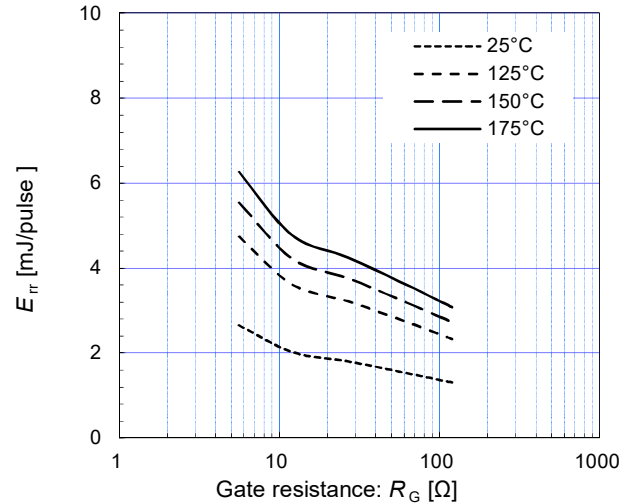
$V_{CC}=600V$, $V_{GE}=+15/-15V$, $R_G=12\Omega$



[Inverter]

E_{rr} vs. Gate resistance (typ.)

$V_{CC}=600V$, $V_{GE}=+15/-15V$, $I_C=75A$



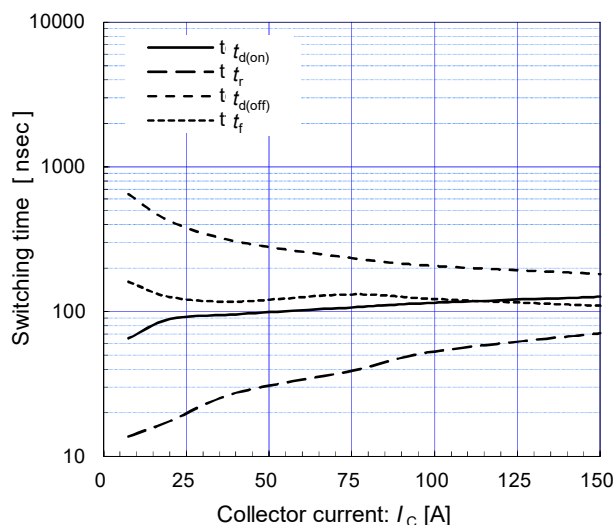
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[Inverter]

Switching time vs. Collector current (typ.)

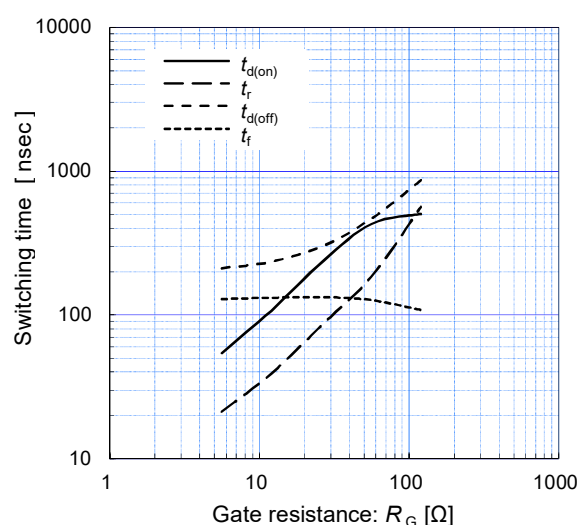
$V_{CC} = 600V$, $R_G = 12\Omega$, $V_{GE} = +15/-15V$, $T_{vj} = 25^\circ C$



[Inverter]

Switching time vs. Gate resistance (typ.)

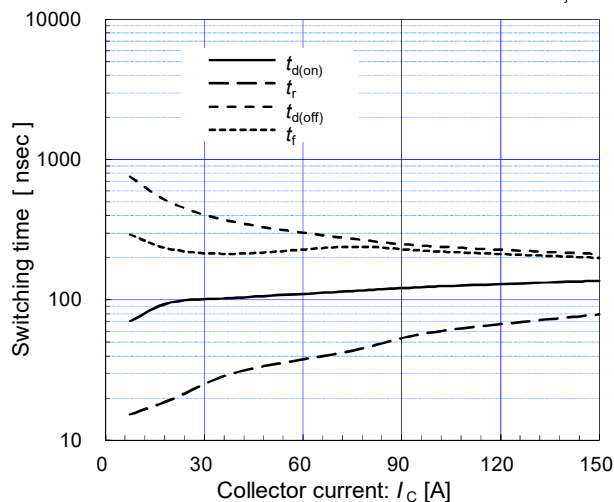
$V_{CC} = 600V$, $I_C = 75A$, $V_{GE} = +15/-15V$, $T_{vj} = 25^\circ C$



[Inverter]

Switching time vs. Collector current (typ.)

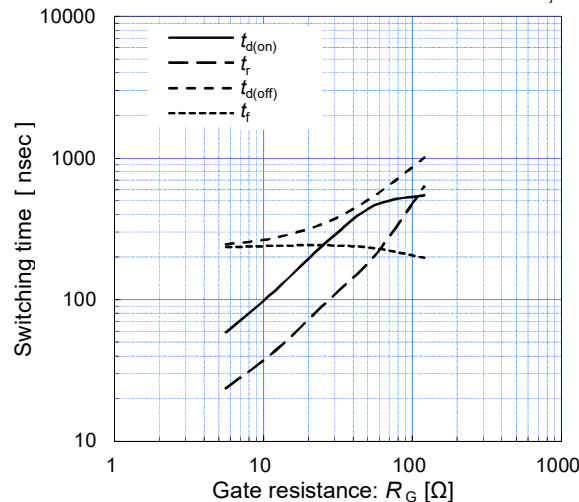
$V_{CC} = 600V$, $R_G = 12\Omega$, $V_{GE} = +15/-15V$, $T_{vj} = 175^\circ C$



[Inverter]

Switching time vs. Gate resistance (typ.)

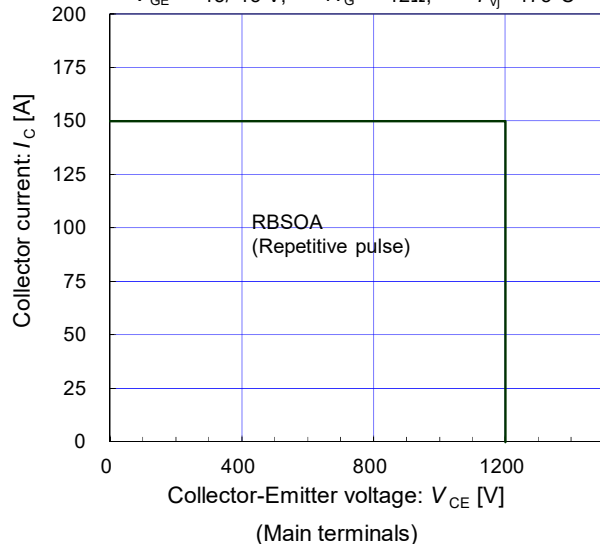
$V_{CC} = 600V$, $I_C = 75A$, $V_{GE} = +15/-15V$, $T_{vj} = 175^\circ C$



[Inverter]

Reverse bias operating area (max.)

$V_{GE} = +15/-15V$, $R_G \geq 12\Omega$, $T_{vj} = 175^\circ C$

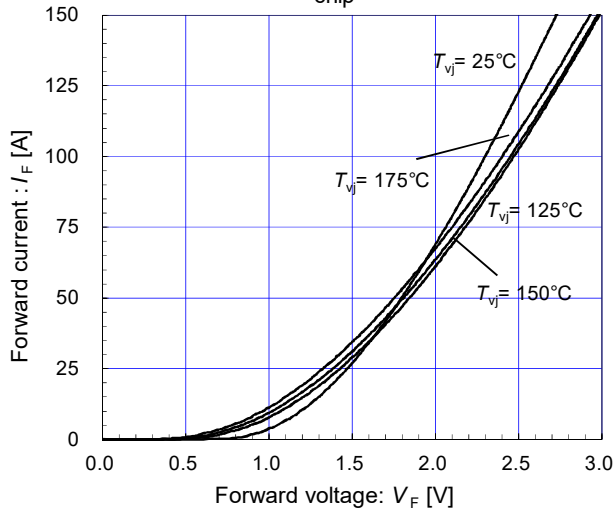


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[Inverter]

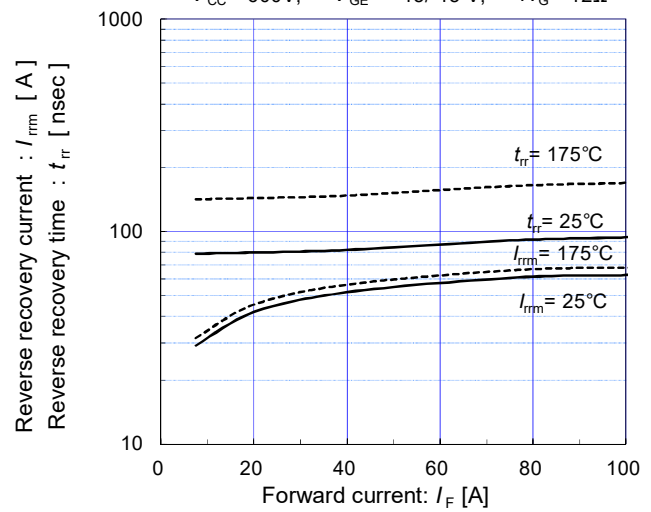
Forward current vs. Forward voltage (typ.)
chip



[Inverter]

Reverse recovery characteristics (typ.)

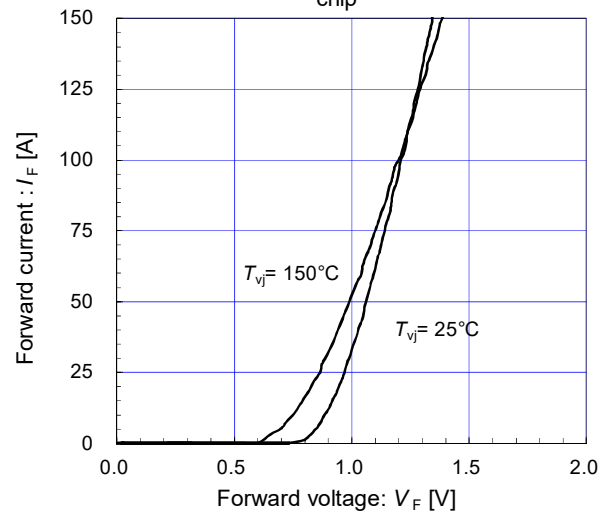
$V_{CC} = 600V$, $V_{GE} = +15/-15V$, $R_G = 12\Omega$



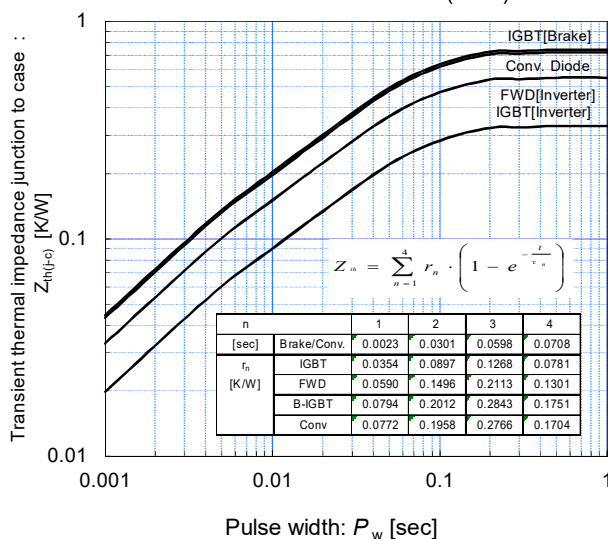
[Converter]

Forward current vs. Forward voltage (typ.)

chip

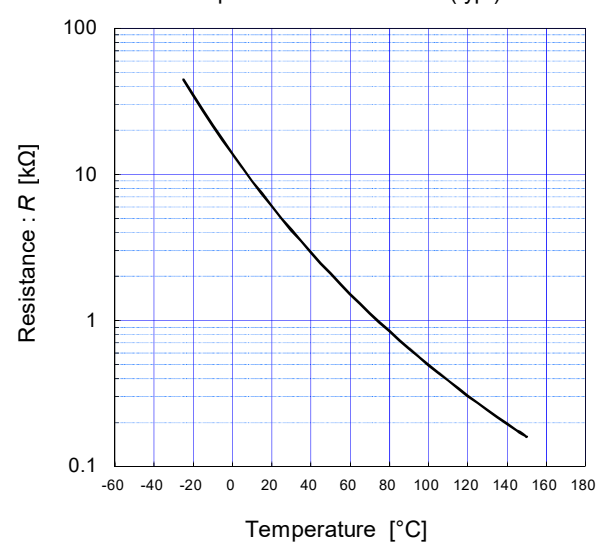


Transient thermal resistance (max.)



[Thermistor]

Temperature characteristic (typ.)



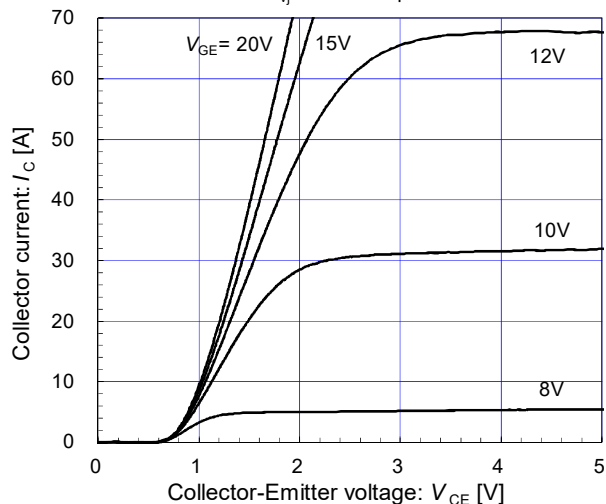
7MBR75XWE120-50

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[Brake]

Collector current vs. Collector-Emitter voltage (typ.)

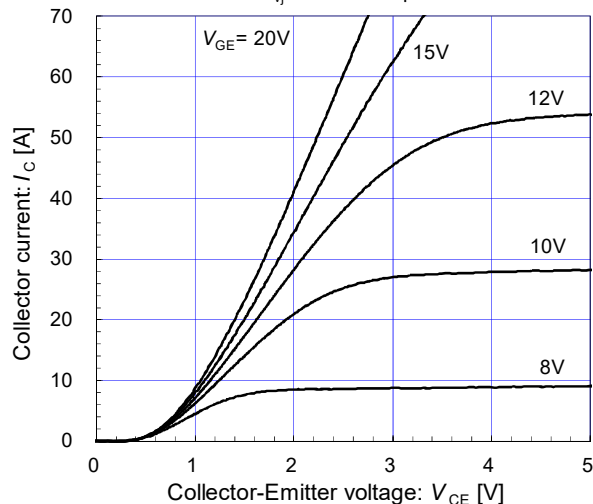
$T_{vj} = 25^\circ\text{C} / \text{chip}$



[Brake]

Collector current vs. Collector-Emitter voltage (typ.)

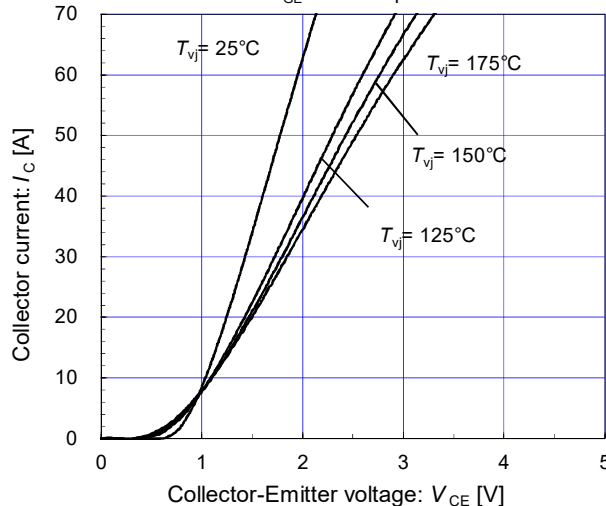
$T_{vj} = 175^\circ\text{C} / \text{chip}$



[Brake]

Collector current vs. Collector-Emitter voltage (typ.)

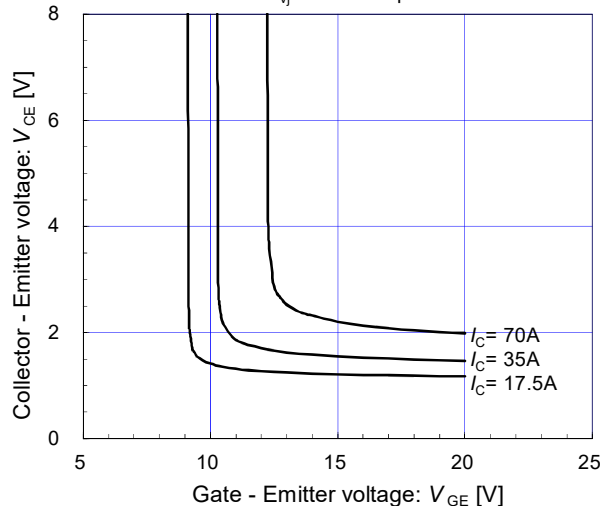
$V_{GE} = 15\text{V} / \text{chip}$



[Brake]

Collector-Emitter voltage vs. Gate-Emmitter voltage (typ.)

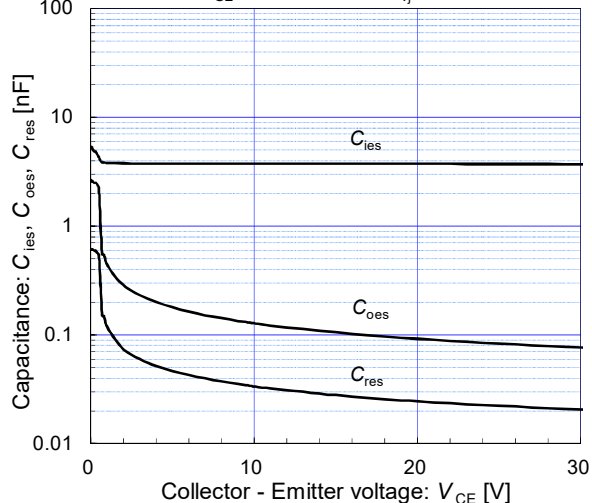
$T_{vj} = 25^\circ\text{C} / \text{chip}$



[Brake]

Capacitance vs. Collector-Emitter voltage (typ.)

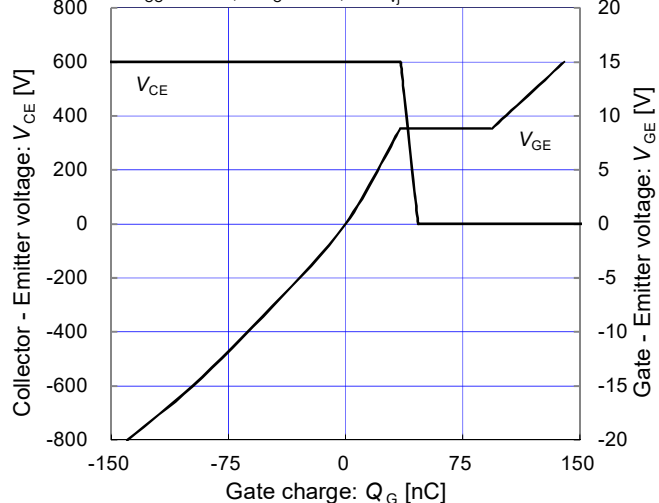
$V_{GE} = 0\text{V}, f = 1\text{MHz}, T_{vj} = 25^\circ\text{C}$



[Brake]

Dynamic gate charge (typ.)

$V_{CC} = 600\text{V}, I_C = 35\text{A}, T_{vj} = 25^\circ\text{C}$



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